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#4/A 112/03

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of)
Bravek, et al.) Examiner Edmondson
Serial Number: 09/917,483) Group Art Unit 1725
Filed: 07/27/2001) **AMENDMENT**
For: Circuit Board Having)
Improved Soldering)
Characteristics)

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

This Amendment is in response to the Office Action mailed August 09, 2002. Please amend the above referenced patent application as follows.

Charge or credit any large business entity fees to Deposit Account 10-0230.

In the Specification

Page 1, paragraph [0001], line 3, in the heading, delete "CO-PENDING" and insert in its place --RELATED--.

Page 3, paragraph [0005], line 31, delete "station" and insert in its place --stations--.

Substitute paragraphs [0001] and [0005] are attached, together with marked-up copies.

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01 FC:1232
02 FC:1201
#10-02-03
84.00 DP

01/17/2003 SDIRETA1 00000032 09917483
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